

## **MOSFET**

### OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V

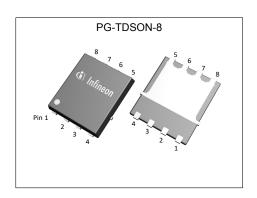
#### **Features**

- N-channel, normal level

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  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  150 °C operating temperature
  Pb-free lead plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target application
  Ideal for high-frequency switching and synchronous rectification

Table 1 **Kev Performance Parameters** 

Parameter	Value	Unit					
<b>V</b> <sub>DS</sub>	150	V					
R <sub>DS(on),max</sub>	11	mΩ					
I <sub>D</sub>	76	А					
Qoss	78	nC					
Q <sub>G</sub> (0V10V)	28	nC					
Q <sub>SW</sub>	11.5	nC					











Type / Ordering Code	Package	Marking	Related Links
BSC110N15NS5	PG-TDSON-8	110N15NS	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V BSC110N15NS5



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## OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V **BSC110N15NS5**



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Cymphal	Values			11	Note / Took Oom did on
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I <sub>D</sub>	-	-	76 48	А	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C
Pulsed drain current <sup>1)</sup>	I <sub>D,pulse</sub>	-	-	304	Α	T <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>2)</sup>	<b>E</b> AS	-	-	100	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	125	W	T <sub>C</sub> =25 °C
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### 2 Thermal characteristics

Table 3 Thermal characteristics

Dovometer	Cymbal	Values			l Init	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	0.6	1	K/W	-
Thermal resistance, junction-ambient, 6 cm <sup>2</sup> cooling area <sup>3)</sup>	R <sub>thJA</sub>	-	-	50	K/W	-

# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Davamatav	Cumbal	Values			11	Nata / Tast Canditian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	150	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	3	3.8	4.6	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=91\ \mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	9 10	11 12.7	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =38 A, V <sub>GS</sub> =8 V, I <sub>D</sub> =19 A,
Gate resistance <sup>4)</sup>	R <sub>G</sub>	-	0.9	1.35	Ω	-
Transconductance	<b>g</b> fs	29	58	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 38 \text{ A}$

See Diagram 3 for more detailed information
 See Diagram 13 for more detailed information
 Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

4) Defined by design. Not subject to production test

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**Table 5** Dynamic characteristics

Parameter.	Or made at		Values			Nata / Tank Oam distant
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	2080	2770	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	515	685	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	13	23	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =75 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	10.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 $\Omega$
Rise time	t <sub>r</sub>	-	3.3	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	14.5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 $\Omega$
Fall time	t <sub>f</sub>	-	2.9	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =38 A, $R_{\rm G,ext}$ =3 $\Omega$

Table 6 Gate charge characteristics<sup>2)</sup>

Devementar	Cumbal	Values			110014	Nata / Tank Operation
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	12	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	5.8	9	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	11.5	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	28	35	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	5.8	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =38 A, $V_{\rm GS}$ =0 to 10 V
Output charge <sup>1)</sup>	Qoss	-	78	103	nC	V <sub>DD</sub> =75 V, V <sub>GS</sub> =0 V

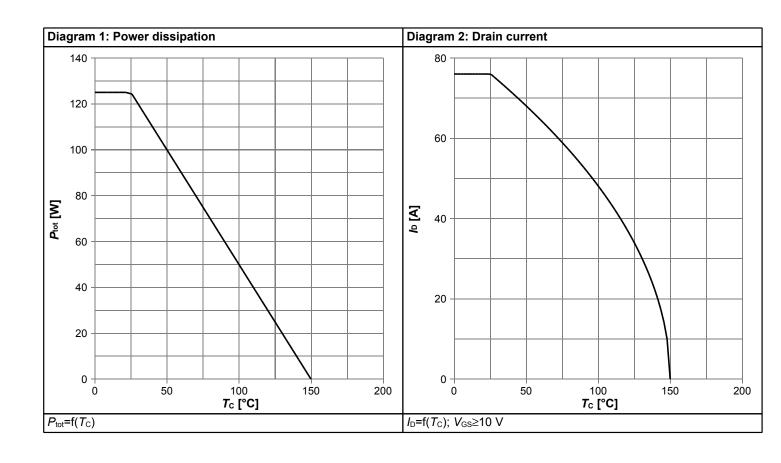
#### Table 7 Reverse diode

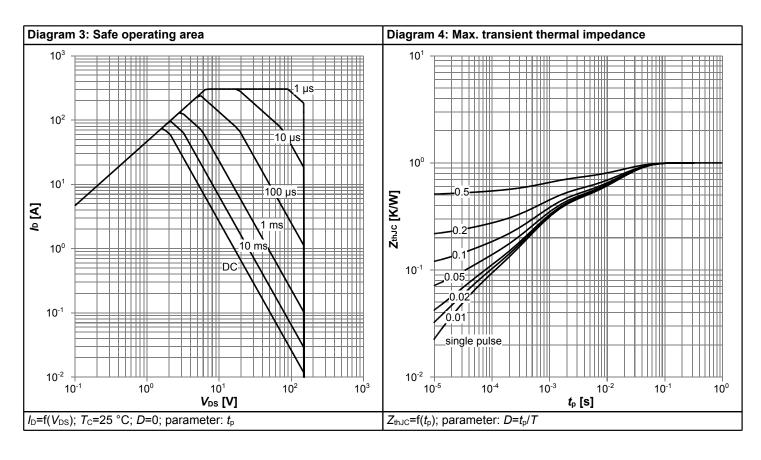
Doromotor	Cumbal		Values	}	l lmi4	Note / Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	86	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	304	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.88	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =38 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	45	90	ns	V <sub>R</sub> =75 V, I <sub>F</sub> =38 A, di <sub>F</sub> /dt=100 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	46	92	nC	V <sub>R</sub> =75 V, I <sub>F</sub> =38 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test  $^{2)}$  See "Gate charge waveforms" for parameter definition

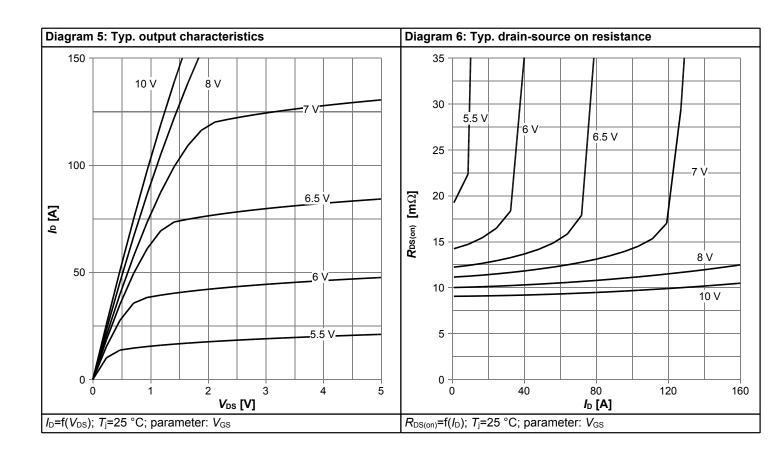


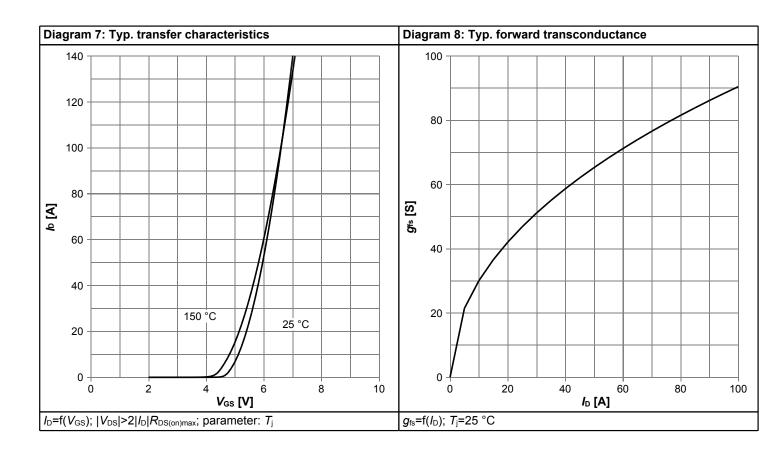
## 4 Electrical characteristics diagrams



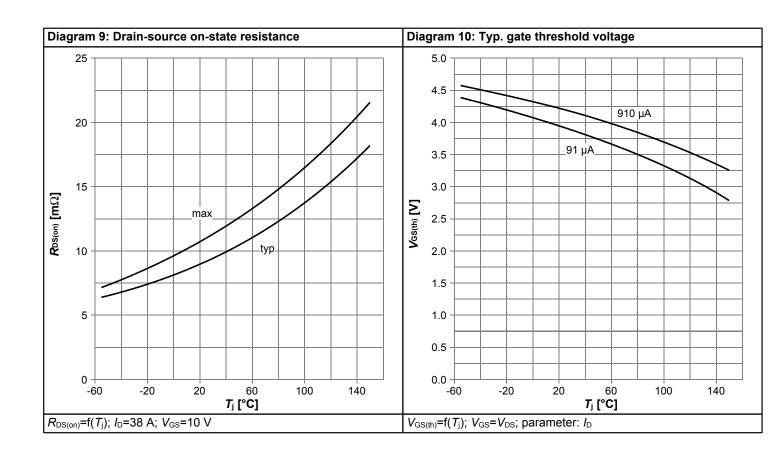


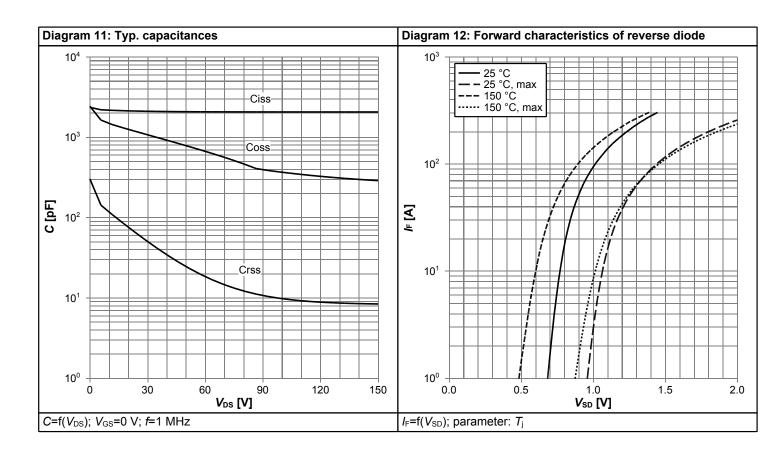




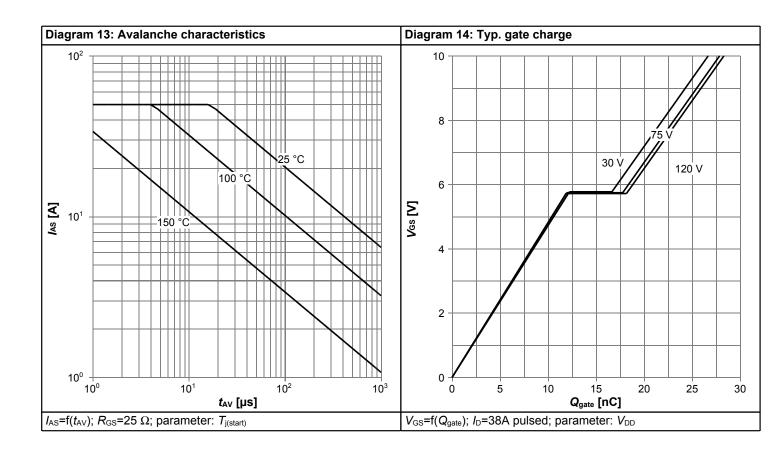


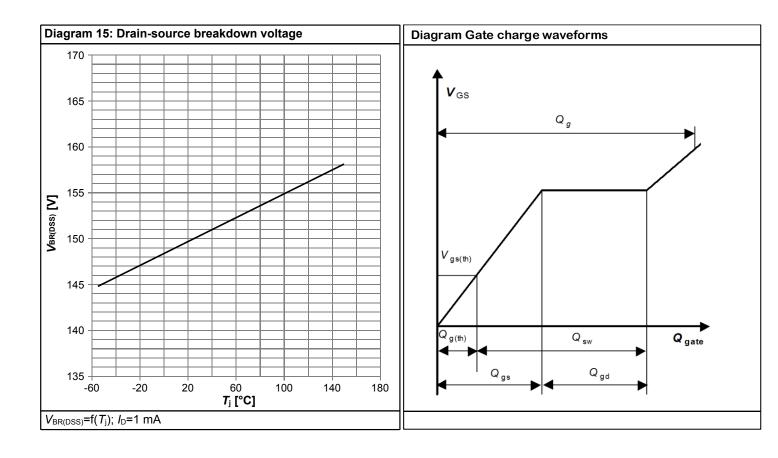






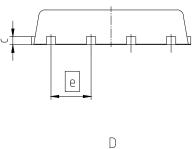


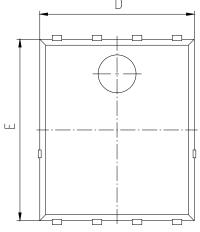


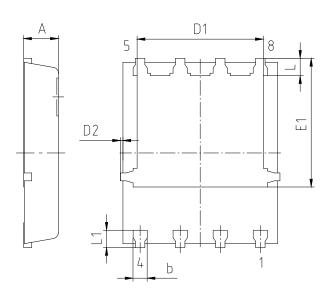




# 5 Package Outlines







PACKAGE - GROUP NUMBER:	PG-TDS	PG-TDSON-8-U08				
DIMENSIONS	MILLIMETERS					
DIMENSIONS	MIN.	MAX.				
Α	0.90	1.20				
b	0.34	0.54				
С	0.15	0.35				
D	4.80	5.35				
D1	3.90	4.40				
D2	0.00	0.22				
E	5.70	6.10				
E1	4.05	4.25				
е	1.27					
L	0.45	0.65				
L1	0.45	0.65				

- 1) EXCLUDING MOLD FLASH
- 2) REMOVAL ON MOLD GATE INTRUSION 0.1 MM PROTRUSION 0.1 MM
- 3) ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

Figure 1 Outline PG-TDSON-8, dimensions in mm

#### OptiMOS<sup>™</sup> 5 Power-Transistor, 150 V **BSC110N15NS5**



#### **Revision History**

BSC110N15NS5

Revision: 2022-11-07, Rev. 2.6

Previous	Revision
Pavision	Date

i icvious i	CVISION	
Revision	Date	Subjects (major changes since last revision)
2.0	2015-05-26	Release of final version
2.1	2015-06-09	Update Avalanche Energy
2.2	2017-09-18	Update Ron max at Vgs=8V
2.3	2018-02-21	Update labels Diagram 9
2.4	2018-05-23	Update date
2.5	2021-05-20	Update Diagram 11 and forward current
2.6	2022-11-07	Update package outline drawing

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